

Málaga, Spain • 2-5 June 2026

6G, Connecting Intelligence

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CALL FOR PAPERS

The 2026 EuCNC & 6G Summit builds on two successful conferences in the area of telecommunications: EuCNC, in its 35th edition, supported by the European Commission, and the 6G Summit, in its 8th edition, originated from the 6G Flagship programme in Finland, one of the very first in its area. The conference is sponsored by the IEEE Communications Society (ComSoc), the European Association for Signal Processing (EURASIP) and the European Association on Antennas and Propagation (EurAAP), and is supported by the European Commission. The conference addresses various aspects of Beyond 5G/6G communication systems and networks. It brings together cutting-edge research and world-renown industries and businesses, attracting in the last years close to 1000 delegates from more than 40 countries to present and discuss the latest results, and more than 70 exhibitors to demonstrate the technology developed in the area, with focus on research projects from EU R&I programmes.

PHY - Physical Laver and Fundamentals

Beyond 5G & 6G and THz communications Reconfigurable radios and new radio heads Massive, Ultra-Massive, extreme, and fluid MIMO Cell-free and distributed massive MIMO Propagation & channels at cm, mm Waves & THz New air interfaces, waveforms, modulation & coding techniques Next generation multiple access (SDMA, NOMA, RSMA) Reconfigurable Intelligent Surfaces Integrated sensing and communication

ess, Optical and Satellite Networks

Beyond 5G & 6G access, metro and core networks Spectrum management and reutilisation Advances in M2M, WSN, IoT networks Novel architectures and protocols for passive optical networks Control planes for access/metro/wireless (converged) networks Optical wireless communications 3D RAN and non-Terrestrial Networking 3D Networks management and orchestration Integrated Communication and Sensing in NTN NTN positioning and GNSS free communications vLEO satellite systems and networks Communications for unmanned platforms (UxV) TSN for industrial communications Green wireless/optical/satellite networks Integrated Sensing and Communications (ISAC) Optical performance monitoring Radio over fibre

Multiband networking

RAN and End-to-end Slicing & QoS

Full-stack automation and orchestration Programmable networking Network and Connectivity as a Service Network digital twin Cloud-Native RAN, OAMs and Edge Computing CI/CD/DevOps methodology for RAN Open RAN and Realtime RAN Control Event-driven network programming Dynamic network slice management Sustainability in networking Zero-touch management of Beyond 5G/6G services Cloud and Edge networking and infrastructure Open-source virtualized service platforms Blockchain in networking Monitoring and analytics in softwarised networks

Distributed LLM training/inference support by 6G

AIU – Applications, IoT, Use ca

Environmental sensing in rural and extreme environments IoT architectures and management techniques Critical communications and public safety Digital health and wellbeing **Emerging Trends in IoT Applications** Augmented and mixed reality Autonomous driving and V2X solutions Factory automation and industrial IoT solutions

OPE - Operational & Experimental Insights

Beyond 5G and 6G trials and experiments Open implementations, testbeds and experiments Evaluation and analysis of experimental data Deployment and integration insights from verticals Plug-and-play deployments and experiments Network forensics & network instrumentation

AI/ML in the PHY and MAC Layer AI/ML for wireless/optical/satellite networks Federated learning and distributed ML for communications AI/ML-native communications AI/ML-based resource and network optimization Semantic communications LLMs for wireless networks GANs in networking Network digital tweens for AI/ML Edge learning in wireless networks RAN intelligence and data-driven networking Observability and business intelligence in RAN Datasets and frameworks enabling AI/ML in networks

SAO – Security Aspects and Quantum Communications

Information theoretic security Physical layer security Network security and cybersecurity trends Cross-laver and zero-touch security Security threats for AI/ML Post-Quantum security Quantum communications & networks Quantum error correction and mitigation

Antenna & RIS system, design, packaging & integration

RF front-end and mm Wave/THz techniques Low power silicon RF, including wake-up
Next generations DSP, incl. RISC V & ASIP
Edge AI component technologies
Optoelectronic integration and fibre/wireless interfaces Digital HW architecture for ultra-high speed & latency PHY New component technologies, including photonics MIMO, OTA and 6G antenna testing Circuits, techniques and architectures for full-duplex Transceivers and architectures for ICAS or full-duplex Hardware design for sustainability and energy-efficiency Modelling and Mitigation of RF Hardware Impairments

NVS - Next-generation Visions and Sustainabili

Vision, use cases, associated requirements, and emerging technology trends for 6G 6G value indicators, performance indicators, interlock metrics 6G business studies and/or regulatory perspectives 6G ecosystem sustainability including relevant vertical aspects 6G coverage and resilience enhancing mechanisms and aspects

Key dates:

EurAAP Liaison

2026-Jan-23: Paper submission deadline 2026-Mar-30: Paper acceptance notification

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and Quantum Communications

& Antennas

2026-Apr-10: Final papers deadline

Jose Molina Garcia Pardo, U. Cartagena, ES EURASIP Liaison















